

# N-Channel PowerTrench<sup>®</sup> MOSFET 100V, 29A, 36m $\Omega$

## Features

- Max  $r_{DS(on)} = 36m\Omega$  at  $V_{GS} = 10V$ ,  $I_D = 5.9A$
- High performance trench technology for extremely low r<sub>DS(on)</sub>
- 100% UIL tested
- RoHS Compliant

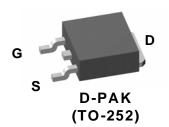


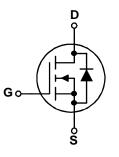
## **General Description**

This N-Channel MOSFET is rugged gate version of Fairchild Semiconductor's advanced Power Trench<sup>®</sup> process. This part is tailored for low  $r_{DS(on)}$  and low Qg figure of merit, with avalanche ruggedness for a wide range of switching applications.

### Applications

- DC-AC Conversion
- Synchronous Rectifier





## MOSFET Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			100	V	
V <sub>GS</sub>	Gate to Source Voltage			±20	V	
I <sub>D</sub>	Drain Current -Continuous (Silicon limited)	$T_C = 25^{\circ}C$		29		
	-Continuous	$T_A = 25^{\circ}C$	(Note 1a)	6.2	A	
	-Pulsed			60		
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	121	mJ	
P <sub>D</sub>	Power Dissipation	T <sub>C</sub> = 25°C		69	W	
	Power Dissipation	T <sub>A</sub> = 25°C	(Note 1a)	3.1		
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature F	Range		-55 to +150	°C	

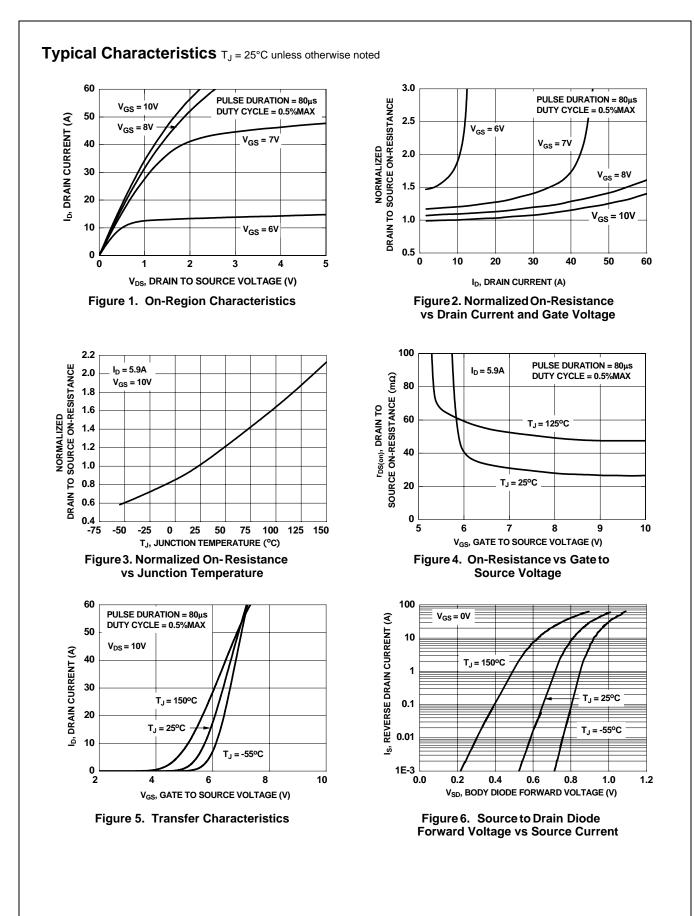
### **Thermal Characteristics**

$R_{\thetaJC}$	Thermal Resistance, Junction to Case	1.8	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient (Note 1a)	40	C/VV

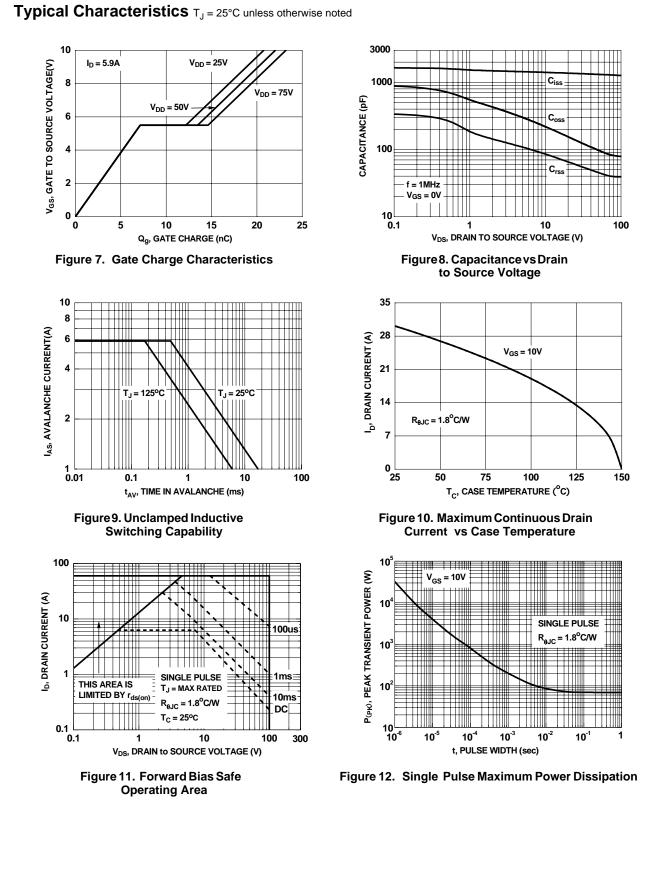
## Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD3860	FDD3860	D-PAK (TO-252)	13"	16mm	2500 units

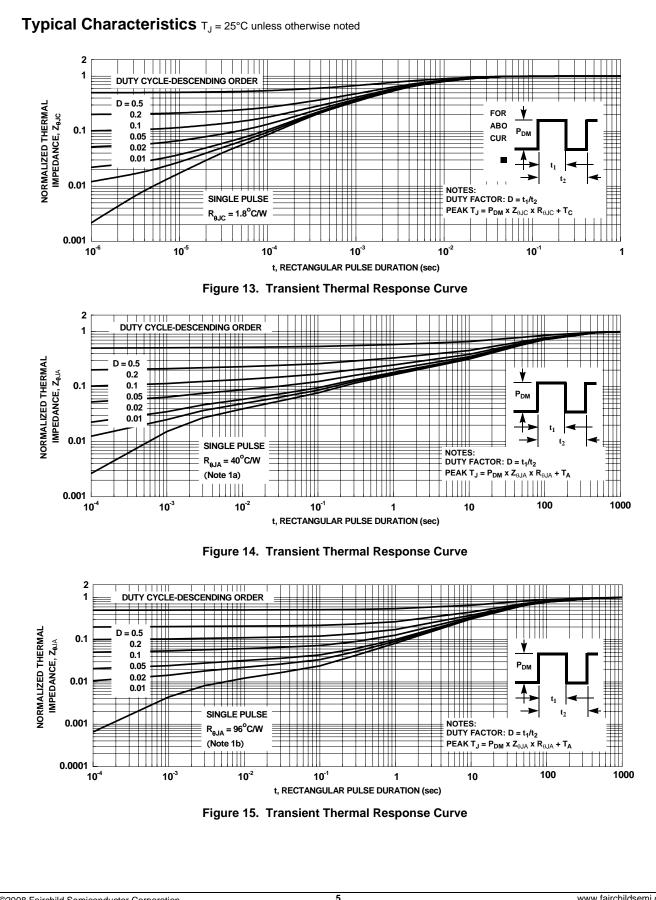
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	I <sub>D</sub> = 250μA, V <sub>GS</sub> = 0V	100			V
∆BV <sub>DSS</sub>	Breakdown Voltage Temperature					
$\Delta T_J$	Coefficient	$I_D = 250\mu A$ , referenced to $25^{\circ}C$		98		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 80V, V_{GS} = 0V$			1	μΑ
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20V, V_{DS} = 0V$			±100	nA
On Chara	cteristics					
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$	2.5	3.8	4.5	V
$\Delta V_{GS(th)}$	Gate to Source Threshold Voltage		2.0		1.0	-
$\Delta T_J$	Temperature Coefficient	$I_D = 250 \mu A$ , referenced to $25^{\circ}C$		-11.4		mV/°C
	Statia Durin ta Cauna On Dagistana	V <sub>GS</sub> = 10V, I <sub>D</sub> = 5.9A		29	36	
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 10V, I <sub>D</sub> = 5.9A, T <sub>J</sub> = 125°C		51	64	mΩ
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 10V, I <sub>D</sub> = 5.9A		20		S
Junamia	Characteristics					
-	Characteristics			4040	4740	- 5
C <sub>iss</sub>	Input Capacitance	$V_{DS} = 50V, V_{GS} = 0V,$		1310	1740	pF
C <sub>oss</sub>	Output Capacitance	f = 1MHz		100	130	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	f 1ML -		45	70	pF
R <sub>g</sub>	Gate Resistance	f = 1MHz		1.6		Ω
Switching	Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time			16	29	ns
t <sub>r</sub>	Rise Time	- V <sub>DD</sub> = 50V, I <sub>D</sub> = 5.9A, $-$ V <sub>GS</sub> = 10V, R <sub>GEN</sub> = 6 $\Omega$ -		10	21	ns
t <sub>d(off)</sub>	Turn-Off Delay Time			24	39	ns
t <sub>f</sub>	Fall Time			7	15	ns
Q <sub>g</sub>	Total Gate Charge at 10V			22	31	nC
Q <sub>gs</sub>	Gate to Source Charge	$V_{DD} = 50V, I_D = 5.9A$		7.1		nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			6.3		nC
Drain-Sou	rce Diode Characteristics					
		V <sub>GS</sub> = 0V, I <sub>S</sub> = 2.0A (Note 2)		0.7	1.2	
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0V, I_S = 2.0A$ (Note 2) $V_{GS} = 0V, I_S = 5.9A$ (Note 2)		0.7	1.2	V
t	Reverse Recovery Time	$v_{GS} = 0.0, \ i_{S} = 5.9A$ (Note 2)		34	55	ns
t <sub>rr</sub> Q <sub>rr</sub>	Reverse Recovery Charge	— I <sub>F</sub> = 5.9A, di/dt = 100A/μs		40	64	nC
Votes:	Reverse Recovery Charge			40	04	no
	m of the junction-to-case and case-to-ambient thermal resinteed by design while R <sub>0JA</sub> is determined by the user's box	ounted on a b) 96		n mounted		e drain pi
	ulse Width < 300μs, Duty cycle < 2.0%. 25°C, L = 3mH, I <sub>AS</sub> = 9A, V <sub>DD</sub> = 100V, V <sub>GS</sub> = 10V.					



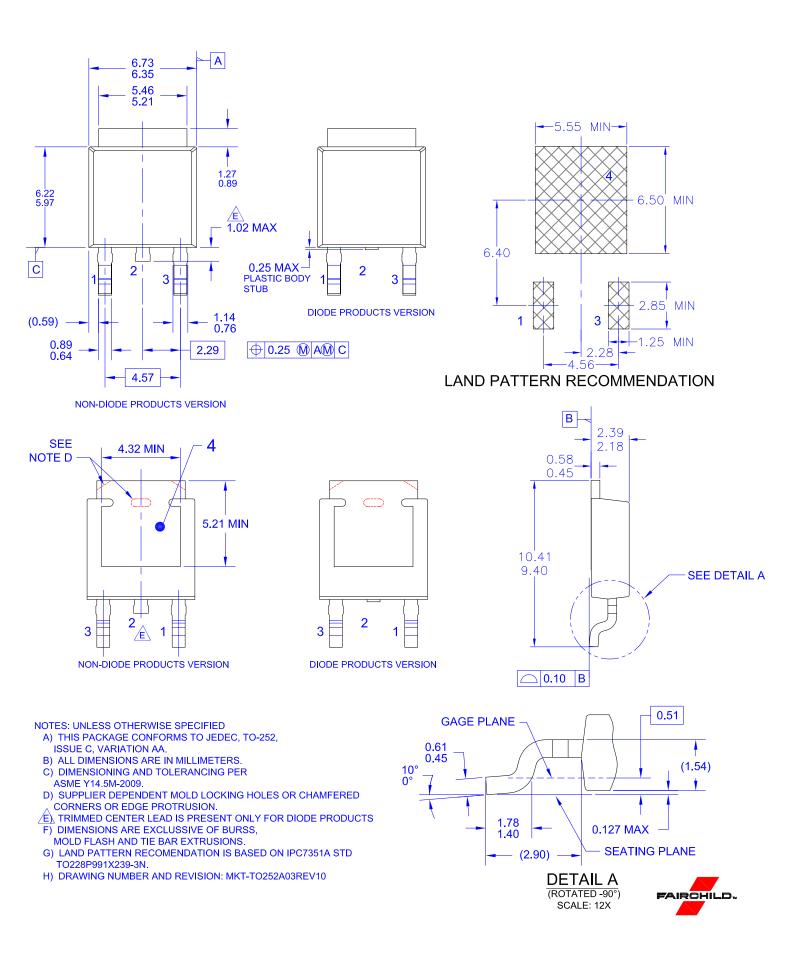


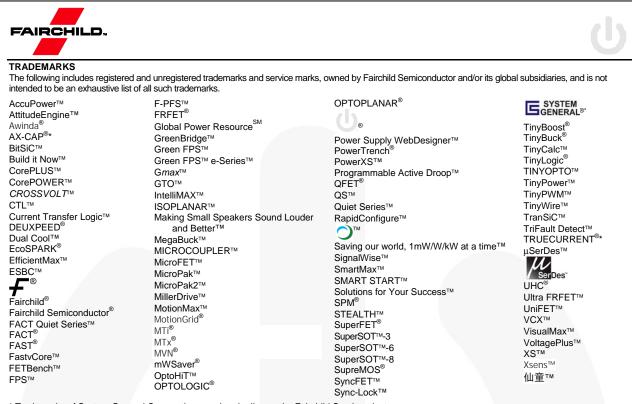


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FDD3860 N-Channel PowerTrench<sup>®</sup> MOSFET





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